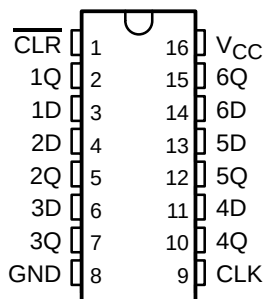


SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

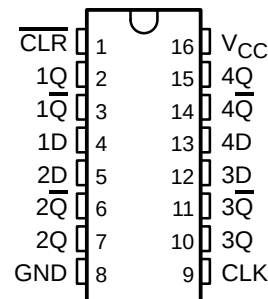
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- 'ALS174 and 'AS174 Contain Six Flip-Flops With Single-Rail Outputs
- 'ALS175 and 'AS175B Contain Four Flip-Flops With Double-Rail Outputs
- Buffered Clock and Direct-Clear Inputs
- Applications Include:
 - Buffer/Storage Registers
 - Shift Registers
 - Pattern Generators
- Fully Buffered Outputs for Maximum Isolation From External Disturbances ('AS Only)

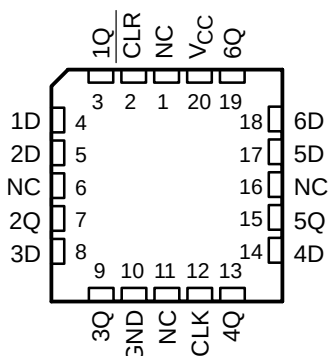
SN54ALS174 . . . J OR W PACKAGE
SN54AS174 . . . J PACKAGE
SN74ALS174, SN74AS174 . . . D, N, OR NS PACKAGE
(TOP VIEW)



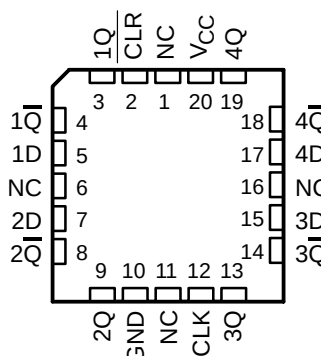
SN54ALS175 . . . J OR W PACKAGE
SN54AS175B . . . J PACKAGE
SN74ALS175, SN74AS175B . . . D, N, OR NS PACKAGE
(TOP VIEW)



SN54ALS174, SN54AS174 . . . FK PACKAGE
(TOP VIEW)



SN54ALS175 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

These positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic. All have a direct-clear ($\overline{\text{CLR}}$) input. The 'ALS175 and 'AS175B feature complementary outputs from each flip-flop.

Information at the data (D) inputs meeting the setup-time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock (CLK) input is at either the high or low level, the D-input signal has no effect at the output.

These circuits are fully compatible for use with most TTL circuits.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

**SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B
SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B
HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR**

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ORDERING INFORMATION

T_A	PACKAGE [†]		ORDERABLE PART NUMBER	TOP-SIDE MARKING
0°C to 70°C	PDIP – N	Tube	SN74ALS174N	SN74ALS174N
			SN74AS174N	SN74AS174N
			SN74ALS175N	SN74ALS175N
			SN74AS175BN	SN74AS175BN
	SOIC – D	Tube	SN74ALS174D	ALS174
		Tape and reel	SN74ALS174DR	
		Tube	SN74AS174D	AS174
		Tape and reel	SN74AS174DR	
		Tube	SN74ALS175D	ALS175
		Tape and reel	SN74ALS175DR	
		Tube	SN74AS175BD	AS175B
		Tape and reel	SN74AS175BDR	
	SOP – NS	Tape and reel	SN74ALS174NSR	ALS174
			SN74AS174NSR	74AS174
			SN74ALS175NSR	ALS175
			SN74AS175BNSR	74AS175B
–55°C to 125°C	CDIP – J	Tube	SNJ54ALS174J	SNJ54ALS174J
			SNJ54AS174J	SNJ54AS174J
			SNJ54ALS175J	SNJ54ALS175J
			SNJ54AS175BJ	SNJ54AS175BJ
	CFP – W	Tube	SNJ54ALS174W	SNJ54ALS174W
			SNJ54ALS175W	SNJ54ALS175W
	LCCC – FK	Tube	SNJ54ALS174FK	SNJ54ALS174FK
			SNJ54ALS175FK	SNJ54ALS175FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

[‡] This orderable is not recommended for new designs.

FUNCTION TABLE
(each flip-flop)

INPUTS			OUTPUTS	
$\overline{\text{CLR}}$	CLK	D	Q	$\overline{Q}^{\S}$
L	X	X	L	H
H	↑	H	H	L
H	↑	L	L	H
H	L	X	Q_0	$\overline{Q}_0$

[§] 'ALS175 and 'AS175B only

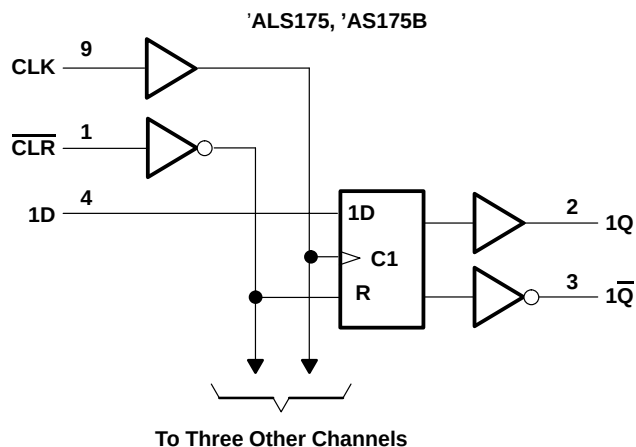
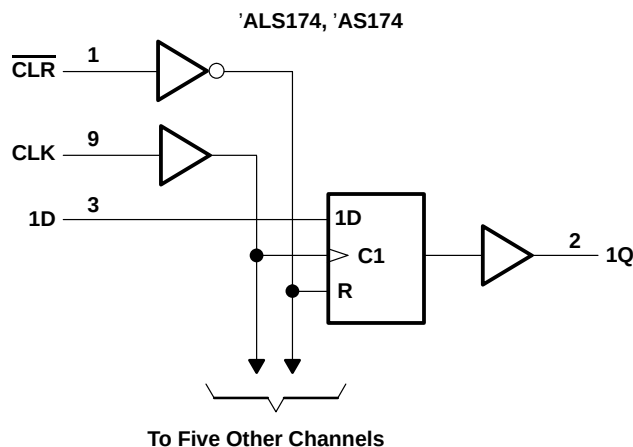


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SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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logic diagrams (positive logic)



Pin numbers shown are for the D, J, N, NS, and W packages.

absolute maximum ratings over operating free-air temperature range, SN54/74ALS174, SN54/74ALS175 (unless otherwise noted)[†]

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Package thermal impedance, θ_{JA} (see Note 1): D package	73°C/W
N package	67°C/W
NS package	64°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 2)

		SN54ALS174 SN54ALS175			SN74ALS174 SN74ALS175			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–0.4			–0.4	mA
I_{OL}	Low-level output current			4			8	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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**SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B
SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B
HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR**

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54ALS174 SN54ALS175			SN74ALS174 SN74ALS175			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V _{IK}		V _{CC} = 4.5 V, I _I = −18 mA		−1.5			−1.5			V
V _{OH}		V _{CC} = 4.5 V to 5.5 V, I _{OH} = −0.4 mA		V _{CC} −2			V _{CC} −2			V
V _{OL}		V _{CC} = 4.5 V	I _{OL} = 4 mA	0.25 0.4		0.25 0.4		0.35 0.5		V
			I _{OL} = 8 mA							
I _I		V _{CC} = 5.5 V, V _I = 7 V		0.1			0.1			mA
I _{IH}		V _{CC} = 5.5 V, V _I = 2.7 V		20			20			μA
I _{IL}	All others	V _{CC} = 5.5 V, V _I = 0.4 V		−0.1			−0.1			mA
	CLK			−0.15						
I _O ‡		V _{CC} = 5.5 V, V _O = 2.25 V		−20 −112		−30 −112		mA		
I _{CC}	'ALS174	V _{CC} = 5.5 V, See Note 3		11 19		11 19		mA		
	'ALS175			8 14		9 14				

[†] All typical values are at V_{CC} = 5 V, T_A = 25°C.

[‡] The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS}.

NOTE 3: I_{CC} is measured with D inputs and CLR grounded, and CLK at 4.5 V.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			SN54ALS174 SN54ALS175		SN74ALS174 SN74ALS175		UNIT
			MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		40		50		MHz
t _w	Pulse duration	CLR low	15		10		ns
		CLK high	12.5		10		
		CLK low	12.5		10		
t _{su}	Setup time before CLK↑	Data	15		10		ns
		CLR inactive	8		6		
t _h	Hold time, data after CLK↑		0		0		ns

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX [§]				UNIT
			SN54ALS174 SN54ALS175		SN74ALS174 SN74ALS175		
			MIN	MAX	MIN	MAX	
f _{max}			40		50		MHz
t _{PLH}	$\overline{\text{CLR}}$	Any Q (or $\overline{\text{Q}}$, 'ALS175)	3	20	5	18	ns
t _{PHL}			5	30	8	23	
t _{PLH}	CLK	Any Q (or $\overline{\text{Q}}$, 'ALS175)	3	20	3	15	ns
t _{PHL}			5	24	5	17	

[§] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR

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absolute maximum ratings over operating free-air temperature range, SN54/74AS174, SN54/74AS175B (unless otherwise noted)[†]

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Package thermal impedance, θ_{JA} (see Note 1): D package	73°C/W
N package	67°C/W
NS package	64°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 2)

		SN54AS174 SN54AS175B			SN74AS174 SN74AS175B			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			–2			–2	mA
I_{OL}	Low-level output current			20			20	mA
T_A	Operating free-air temperature	–55		125	0		70	°C

NOTE 2: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	SN54AS174 SN54AS175B			SN74AS174 SN74AS175B			UNIT
		MIN	TYP [‡]	MAX	MIN	TYP [‡]	MAX	
V_{IK}	$V_{CC} = 4.5$ V, $I_I = -18$ mA			–1.2			–1.2	V
V_{OH}	$V_{CC} = 4.5$ V to 5.5 V, $I_{OH} = -2$ mA	$V_{CC}-2$			$V_{CC}-2$			V
V_{OL}	$V_{CC} = 4.5$ V, $I_{OL} = 20$ mA	0.35	0.5		0.35	0.5		V
I_I	$V_{CC} = 5.5$ V, $V_I = 7$ V		0.1			0.1		mA
I_{IH}	$V_{CC} = 5.5$ V, $V_I = 2.7$ V		20			20		μA
I_{IL}	$V_{CC} = 5.5$ V, $V_I = 0.4$ V		–0.5			–0.5		mA
$I_{O}^{\S}$	$V_{CC} = 5.5$ V, $V_O = 2.25$ V	–30		–112	–30		–112	mA
I_{CC}	'AS174		30	45		30	45	mA
	'AS175B		22.5	34		22.5	34	

[‡] All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

^{\S} The output conditions have been chosen to produce a current that closely approximates one-half of the true short-circuit output current, I_{OS} .

NOTE 4: I_{CC} is measured with D inputs, CLR, and CLK grounded.



**SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B
SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B
HEX/QUADRUPLE D-TYPE FLIP-FLOPS WITH CLEAR**

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timing requirements over recommended operating free-air temperature range (unless otherwise noted)

				SN54AS174 SN54AS175B		SN74AS174 SN74AS175B		UNIT	
				MIN	MAX	MIN	MAX		
f _{clock} *	Clock frequency			100		100		MHz	
t _w *	Pulse duration		CLR low		5.5		5		ns
			CLK high		4		4		
			CLK low	'AS174	6		6		
			CLK low	'AS175B	5		5		
t _{su} *	Setup time before CLK↑		Data	'AS174	4		4		ns
				'AS175B	3		3		
			CLR inactive		6		6		
t _h *	Hold time, data after CLK↑			1		1		ns	

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data, but is not production tested.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX†				UNIT
			SN54AS174		SN74AS174		
			MIN	MAX	MIN	MAX	
f _{max} *			100		100		MHz
t _{PHL}	CLR	Any Q	5	15	5	14	ns
t _{PLH}	CLK	Any Q	3.5	9.5	3.5	8	ns
t _{PHL}			4.5	11.5	4.5	10	

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data, but is not production tested.

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R _L = 500 Ω, T _A = MIN to MAX†				UNIT
			SN54AS175B		SN74AS175B		
			MIN	MAX	MIN	MAX	
f _{max} *			100		100		MHz
t _{PLH}	$\overline{\text{CLR}}$	Any Q or $\overline{\text{Q}}$	4	10	4	9	ns
t _{PHL}			4.5	15	4.5	13	
t _{PLH}	CLK	Any Q or $\overline{\text{Q}}$	3	8.5	3	7.5	ns
t _{PHL}			3	11	3	10	

* On products compliant to MIL-STD-883, Class B, this parameter is based on characterization data, but is not production tested.

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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NOTES:

- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
- D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
- E. The outputs are measured one at a time with one transition per measurement.

7

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
5962-9553701QEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9553701QE A SNJ54AS175BJ
83019012A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	83019012A SNJ54ALS 174FK
8301901EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301901EA SNJ54ALS174J
8301901FA	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301901FA SNJ54ALS174W
8301902EA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301902EA SNJ54ALS175J
JM38510/37201B2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37201B2A
JM38510/37201B2A.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37201B2A
JM38510/37201BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37201BEA
JM38510/37201BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37201BEA
JM38510/37202B2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37202B2A
JM38510/37202B2A.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37202B2A
JM38510/37202BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37202BEA
JM38510/37202BEA.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37202BEA
M38510/37201B2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37201B2A
M38510/37201BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37201BEA
M38510/37202B2A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37202B2A

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
M38510/37202BEA	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	JM38510/ 37202BEA
SN54ALS174J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS174J
SN54ALS174J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS174J
SN54ALS175J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS175J
SN54ALS175J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SN54ALS175J
SN74ALS174D	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	0 to 70	ALS174
SN74ALS174DR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS174
SN74ALS174DR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS174
SN74ALS174N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS174N
SN74ALS174N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS174N
SN74ALS174NSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS174
SN74ALS174NSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS174
SN74ALS175D	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	0 to 70	ALS175
SN74ALS175DR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS175
SN74ALS175DR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS175
SN74ALS175N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS175N
SN74ALS175N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74ALS175N
SN74ALS175NSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS175
SN74ALS175NSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS175
SN74AS174D	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	AS174
SN74AS174D.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	AS174
SN74AS174N	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS174N
SN74AS174N.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS174N
SN74AS174NSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS174
SN74AS174NSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS174
SN74AS175BD	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS175B
SN74AS175BD.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS175B
SN74AS175BN	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS175BN
SN74AS175BN.A	Active	Production	PDIP (N) 16	25 TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN74AS175BN
SN74AS175BNSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS175B

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74AS175BNSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS175B
SNJ54ALS174FK	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	83019012A SNJ54ALS 174FK
SNJ54ALS174FK.A	Active	Production	LCCC (FK) 20	55 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	83019012A SNJ54ALS 174FK
SNJ54ALS174J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301901EA SNJ54ALS174J
SNJ54ALS174J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301901EA SNJ54ALS174J
SNJ54ALS174W	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301901FA SNJ54ALS174W
SNJ54ALS174W.A	Active	Production	CFP (W) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301901FA SNJ54ALS174W
SNJ54ALS175J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301902EA SNJ54ALS175J
SNJ54ALS175J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	8301902EA SNJ54ALS175J
SNJ54AS174J	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54AS174J
SNJ54AS174J.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	SNJ54AS174J
SNJ54AS175BJ	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9553701QE A SNJ54AS175BJ
SNJ54AS175BJ.A	Active	Production	CDIP (J) 16	25 TUBE	No	SNPB	N/A for Pkg Type	-55 to 125	5962-9553701QE A SNJ54AS175BJ

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54ALS174, SN54ALS175, SN54AS174, SN54AS175B, SN74ALS174, SN74ALS175, SN74AS174, SN74AS175B :

- Catalog : [SN74ALS174](#), [SN74ALS175](#), [SN74AS174](#), [SN74AS175B](#)
- Military : [SN54ALS174](#), [SN54ALS175](#), [SN54AS174](#), [SN54AS175B](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

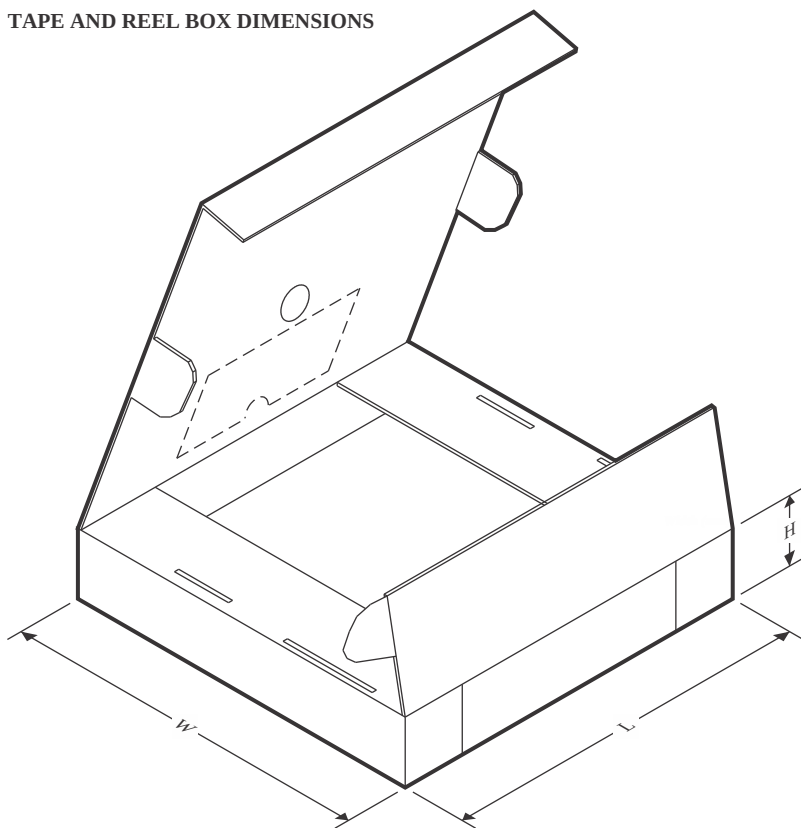
TAPE AND REEL INFORMATION



*All dimensions are nominal

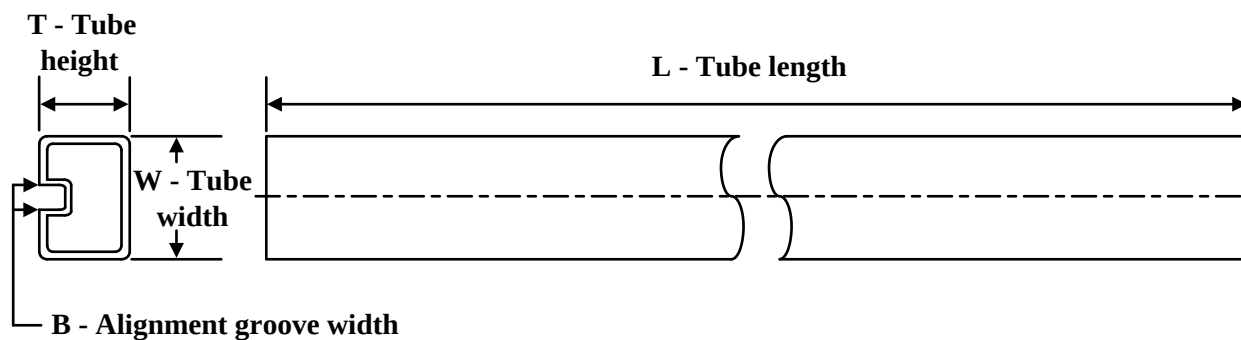
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS174DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74ALS174NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74ALS175DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74ALS175NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74AS174NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1
SN74AS175BNSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS174DR	SOIC	D	16	2500	353.0	353.0	32.0
SN74ALS174NSR	SOP	NS	16	2000	353.0	353.0	32.0
SN74ALS175DR	SOIC	D	16	2500	353.0	353.0	32.0
SN74ALS175NSR	SOP	NS	16	2000	353.0	353.0	32.0
SN74AS174NSR	SOP	NS	16	2000	353.0	353.0	32.0
SN74AS175BNSR	SOP	NS	16	2000	353.0	353.0	32.0

TUBE


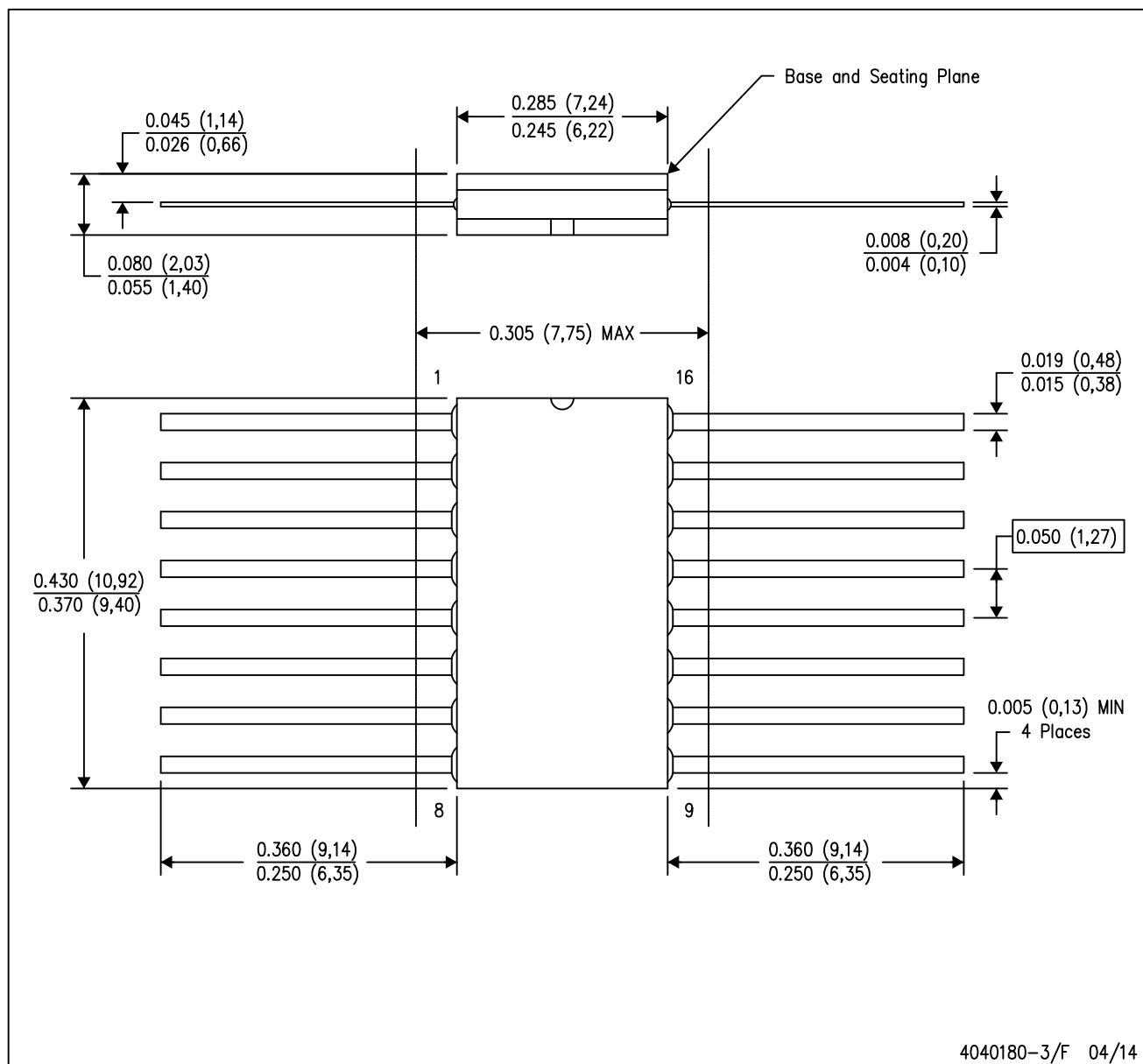
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
83019012A	FK	LCCC	20	55	506.98	12.06	2030	NA
8301901FA	W	CFP	16	25	506.98	26.16	6220	NA
JM38510/37201B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/37201B2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/37202B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
JM38510/37202B2A.A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/37201B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
M38510/37202B2A	FK	LCCC	20	55	506.98	12.06	2030	NA
SN74ALS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS174N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS174N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS175N	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS175N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74ALS175N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS174D	D	SOIC	16	40	507	8	3940	4.32
SN74AS174D.A	D	SOIC	16	40	507	8	3940	4.32
SN74AS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS174N	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS174N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS174N.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS175BD	D	SOIC	16	40	507	8	3940	4.32
SN74AS175BD.A	D	SOIC	16	40	507	8	3940	4.32
SN74AS175BN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS175BN	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS175BN.A	N	PDIP	16	25	506	13.97	11230	4.32
SN74AS175BN.A	N	PDIP	16	25	506	13.97	11230	4.32
SNJ54ALS174FK	FK	LCCC	20	55	506.98	12.06	2030	NA

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SNJ54ALS174FK.A	FK	LCCC	20	55	506.98	12.06	2030	NA
SNJ54ALS174W	W	CFP	16	25	506.98	26.16	6220	NA
SNJ54ALS174W.A	W	CFP	16	25	506.98	26.16	6220	NA

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only.
 - Falls within MIL STD 1835 GDFP2-F16

GENERIC PACKAGE VIEW

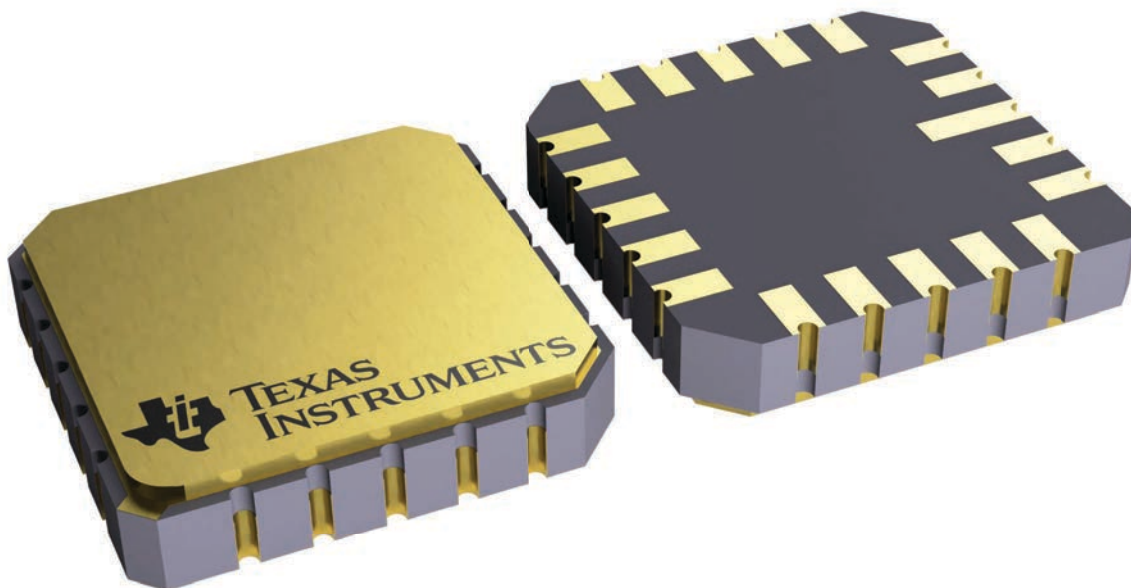
FK 20

LCCC - 2.03 mm max height

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

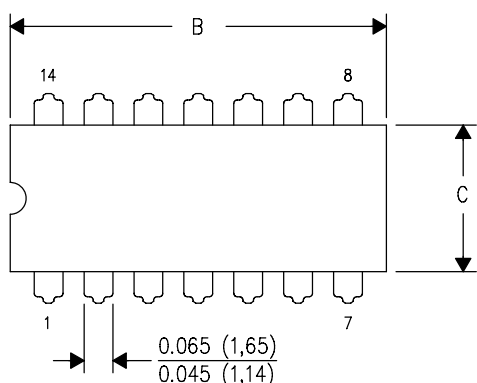


4229370VA\

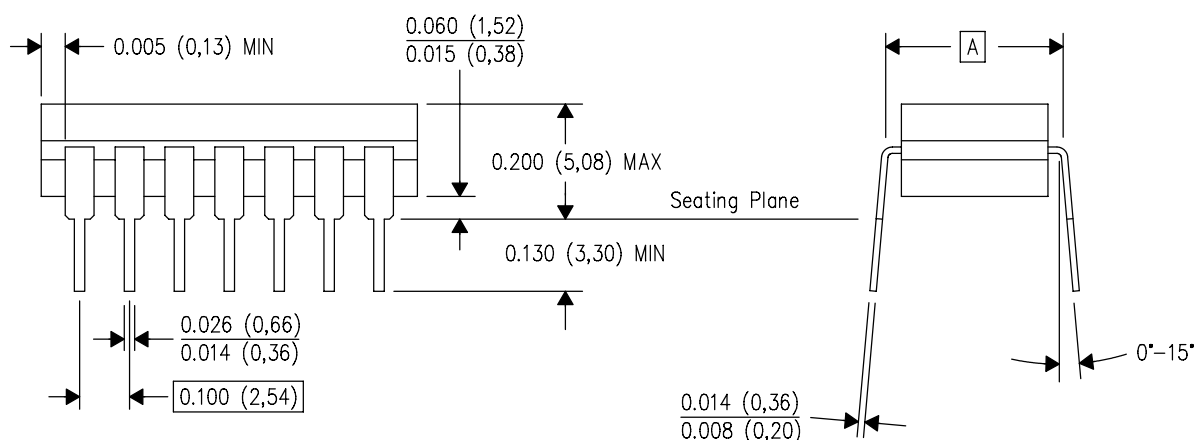
J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



PINS ** DIM	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



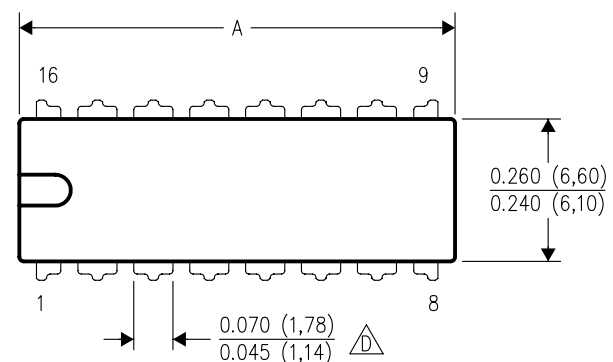
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package is hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

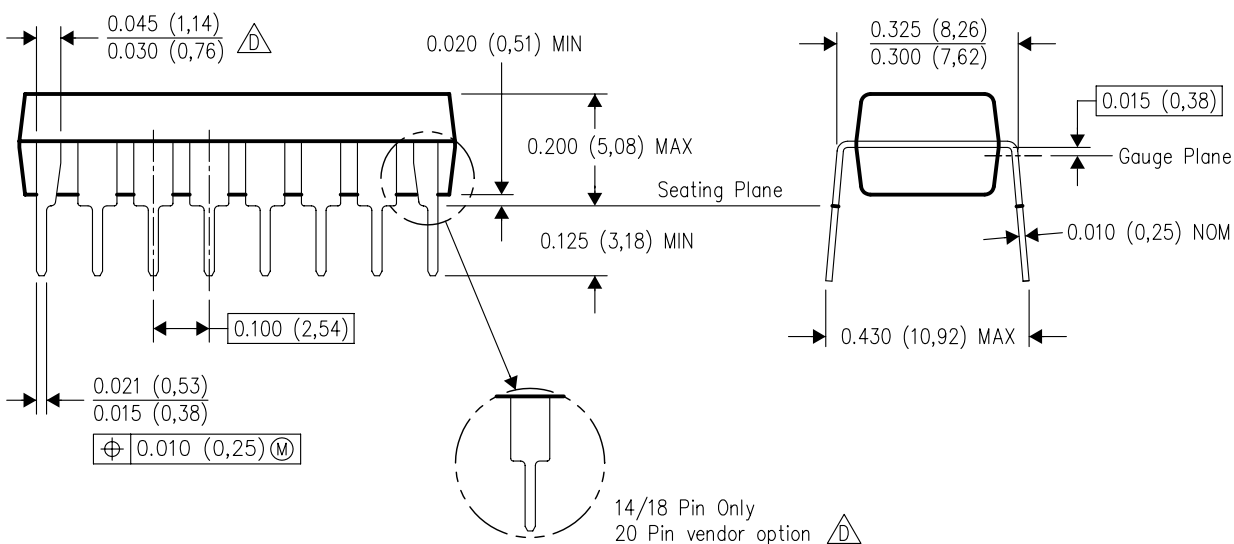
N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



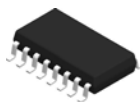
PINS ** DIM	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS-001 VARIATION	AA	BB	AC	AD



4040049/E 12/2002

NOTES:

- A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
-  Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 The 20 pin end lead shoulder width is a vendor option, either half or full width.

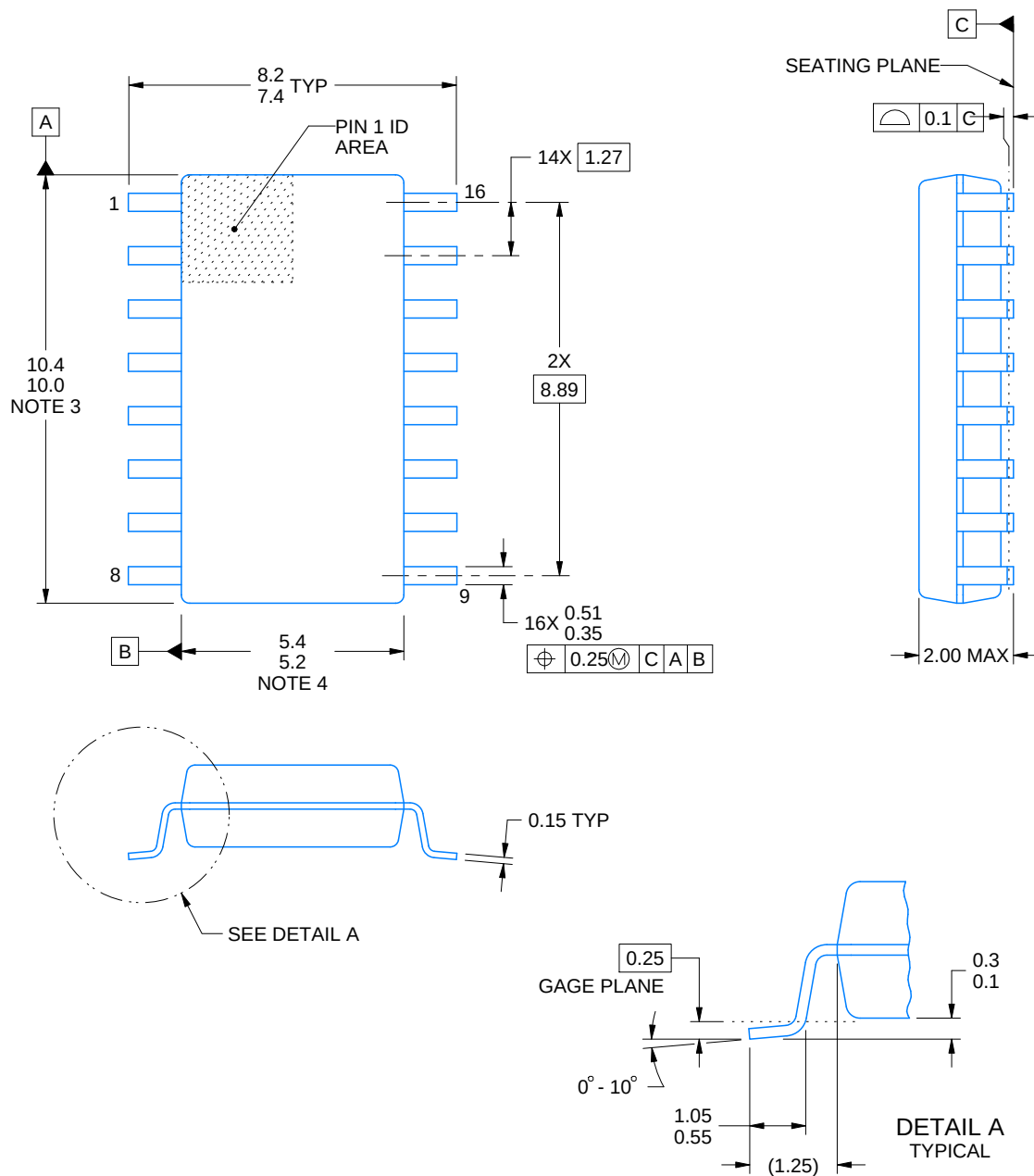


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

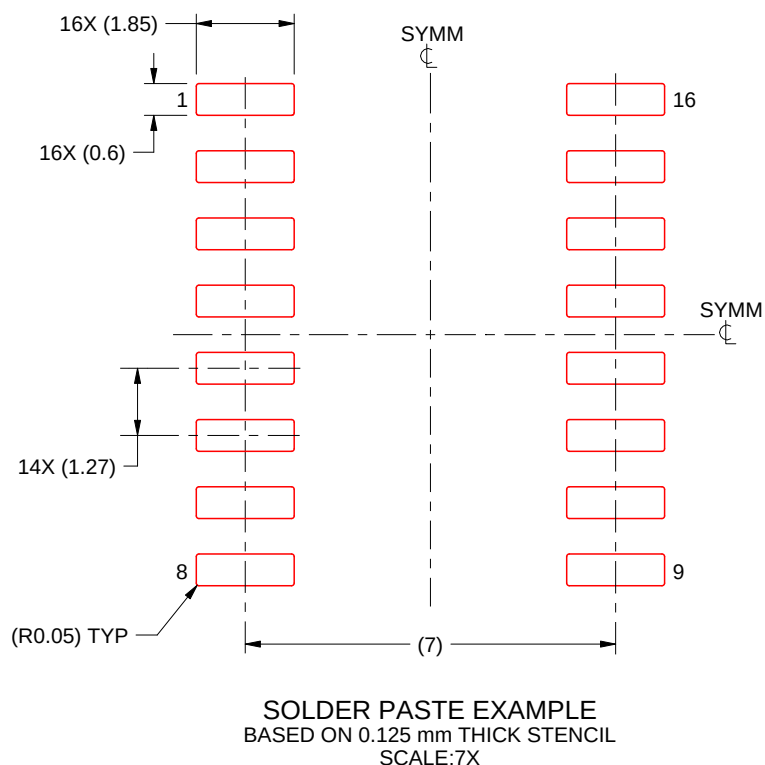
SOP



4220735/A 12/2021

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



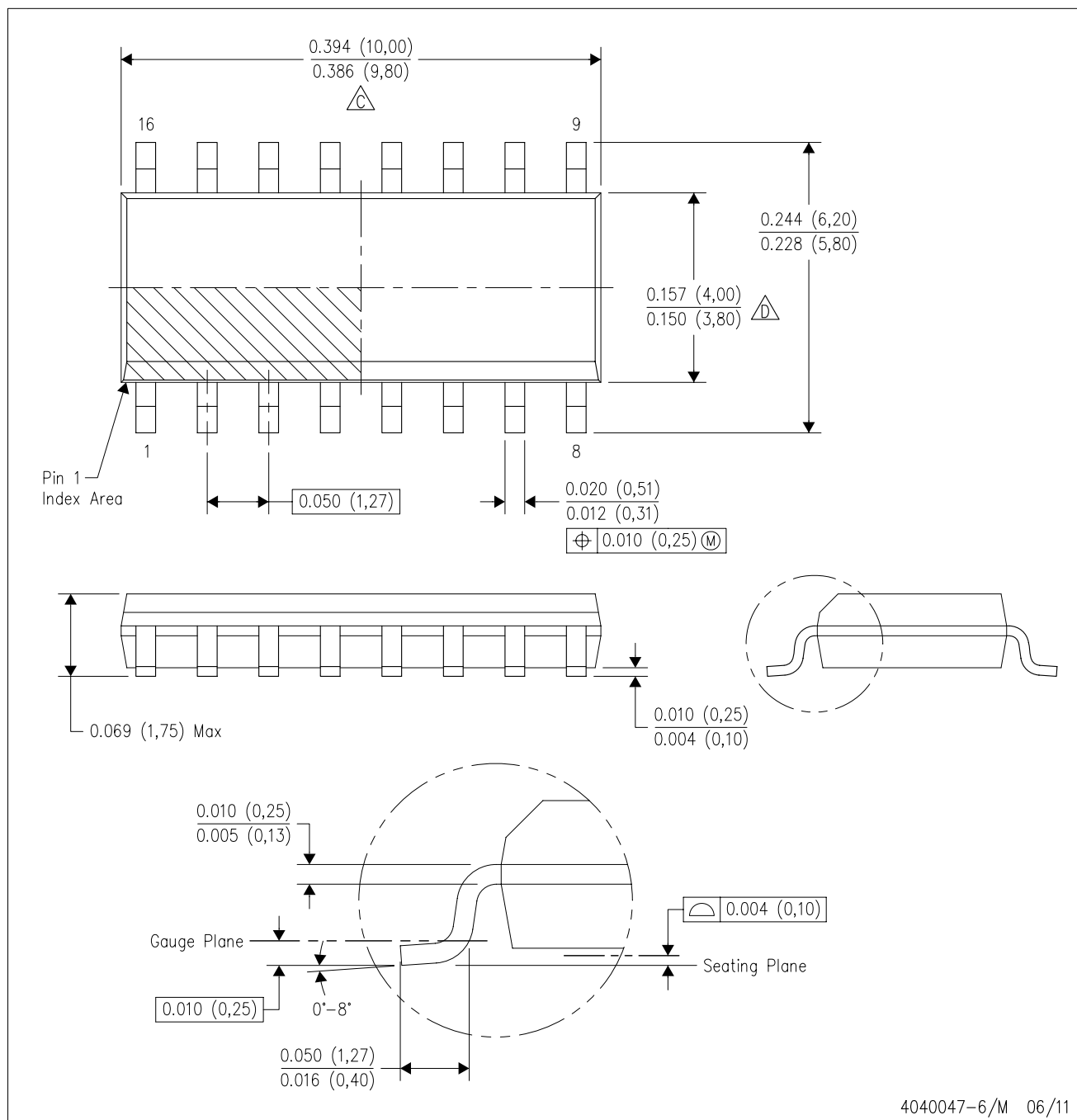
4220735/A 12/2021

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



4040047-6/M 06/11

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.

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